

Product environmental attributes - THE ECO DECLARATION

The declaration may be published only when all rows and/or fields marked with an * are filled-in (n.a. for not applicable).

Additional information regarding each item may be found under P14.

Brand *	Lenovo	Logo		
Company name *	Lenovo			
Contact information *	Lenovo Global Environmental Affairs Alvin L Carter 1009 Think Place Building 2 / 5J3 Morrisville, North Carolina 27560 alcarter@lenovo.com	lenovo		
Internet site *	http://www.lenovo.com/social_responsibility/us/en/environment.html			
Additional information				

The company declares (based on product specification or test results based obtained from sample testing), that the product conforms to the statements given in this declaration.				
Type of product *	Notebook PC			
Commercial name *	Lenovo G560e			
Model number *	20107;1050			
Issue date *	2011-1-17			
Intended market *	☐ Global ☐ Europe ☐ Asia, Pacific & Japan ☐ Americas ☐ Other			
Additional information	ENERGY STAR® 5.0 Qualified; EPEAT Gold Rating, GREENGUARD Certified			

This is an uncontrolled copy when in printed form. Please refer to the contact information for the latest version.

Quality	Requireme	nt met	
Item		Yes	No
QC1 *	The company enforces an internal quality control scheme to ensure the correctness of this eco declaration	\boxtimes	
QC2 *	The company is a member of an eco declaration system that enforces regular independent quality control such as organized by IT-Företagen (see www.itecodeclaration.org).	ol 🔀	

Model number *	Lenovo G560e		
Issue date *	2011-1-17	Logo	lenovo

Product	oduct environmental attributes - Legal requirements					
Item		Yes	No	n.a.		
P1	Hazardous substances and preparations					
P1.1*	Products do not contain more than; 0.1% lead, 0.01% cadmium, 0.1% mercury, 0.1% hexavalent chromium, 0.1% polybrominated biphenyls (PBB) or 0.1% polybrominated diphenyl ethers (PBDE). (See legal reference and Note B1)					
P1.2*	Products do not contain Asbestos (see legal reference). Comment: Legal reference has no maximum concentration value.					
P1.3*	Products do not contain Ozone Depleting Substances: Chlorofluorocarbons (CFC), hydrobromofluorocarbons (HBFC), hydrochlorofluorcarbons (HCFC), Halons, carbontetrachloride, 1,1,1-trichloroethane, methyl bromide (see legal reference). Comment: Legal reference has no maximum concentration values.					
P1.4*	Products do not contain more than; 0.005% polychlorinated biphenyl (PCB), 0.005% polychlorinated terphenyl (PCT) in preparations (see legal reference).					
P1.5*	Products do not contain more than 0.1% short chain chloroparaffins (SCCP) with 10-13 carbon atoms in the chain containing at least 48% per mass of chlorine in the SCCP (see legal reference).					
P1.6*	Textile and leather parts with direct skin contact do not contain Tri-(2,3,-dibromopropyl)-phosphate (TRIS), Tris-(aziridinyl)-phosphineoxide (TEPA), polybrominated biphenyl (PBB) (see legal reference). Comment: Legal reference has no maximum concentration values.					
P1.7*	Textile and leather parts with direct skin contact do not contain more than 0.003% Azo colorants that split aromatic amines. (See legal reference and Note B1)			\boxtimes		
P1.8*	Wooden parts do not contain arsenic and chromium as a wood preservation treatment as well as pentachlorophenol and derivatives (see legal reference). Comment: Legal reference has no maximum concentration values.					
P1.9*	Parts with direct and prolonged skin contact do not release nickel in concentrations above 0.5 microgram/cm ² /week (see legal reference). Comment: Max limit in legal reference when tested according to EN1811:1998.					
P1.10*	REACH Article 33 information about substances in articles is available at (add URL or mail contact): http://www.lenovo.com/social_responsibility/us/en/ThinkGreen_products.html#environment					
P2	Batteries					
P2.1*	If the product contains a battery or an accumulator, it is labeled with the disposal symbol and if it contains more than 0.0005% of mercury (for button cells only) by weight, or more than 0.004% of lead, it shall be marked with the chemical symbol for the metal concerned, Hg or Pb. Information on proper disposal is provided in user manual. (See legal reference)					
P2.2*	Button cells used in the product do not contain more than 2% by weight of mercury. Other batteries or accumulators do not contain more than 0.0005% of mercury or 0.002% of cadmium. (See legal reference)	\boxtimes				
P2.3*						
P3	Safety, EMC connection to the telephone network and labeling					
P3.1*	The product complies with legally required safety standards as specified (see legal reference).	\square	П			
P3.2*	The product complies with legally required standards for electromagnetic compatibility (see legal reference).					
P3.3*	If product is intended for connection to a public telecom network or contains a radio transmitter, it complies with legally required standards for radio and telecommunication devices (see legal reference).	; <u></u>				
P3.4*	The product is labeled to show conformance with applicable legal requirements (see legal reference).					
P4	Consumable materials					
P4.1*	If a photo conductor (drum, belt etc.) is used in the product, it does not contain cadmium max 0.01% (see legal reference and Note B1).			\boxtimes		
P4.2*	If ink/toner is used in the product, it does not contain cadmium max 0.1% by weight (see legal reference).		\Box	$\overline{\mathbf{X}}$		
P4.3*	If the ink/toner formulation/preparation is classified as hazardous according to applicable regulations, the product/packaging is adequately labeled and a Safety Data Sheet (SDS) in accordance with these requirements is available (see legal reference).					
P5	Product packaging					
P5.1*	Packaging and packaging components do not contain more than 0.01% lead, mercury, cadmium and hexavalent chromium by weight of these together.	d 🔀				
P5.2*	Plastic packaging material is marked according to ISO 11469 referring ISO 1043 (see legal reference).	\boxtimes				
P5.3*	The product packaging material is free from ozone depleting substances as specified in the Montrea Protocol (see legal reference). Comment: Legal reference has no maximum concentration values.	al 🔀				

Note B1: Restriction applies to the homogeneous material, unless other specified and expressed in weight %.

Model number *	Lenovo G560e		
Issue date *	2011-1-17	Logo	lenovo

**mandatory to fill in. Additional information regarding each item may be found under P14. **pestiment information P6.1* Information for recyclers/treatment facilities is available (see legal reference). **property	Product	environmental attributes - Market requirements - Environmental conscious design	equire	ment	met
P7 Design Disassembly, recycling P7.10 Parts that have to be treated separately are easily separable P7.21 Parts that have to be treated separately are easily separable P7.22 Plastic materials in covers/housing have no surface coating. P7.3 Plastic parts >100 consist of one material or of easily separable materials. P7.4 Plastic parts >25g have material codes according to ISO 11469 referring ISO 1043. P7.5 Plastic parts >25g have material codes according to ISO 11469 referring ISO 1043. P7.6 Labels are easily separable. (This requirement does not apply to safety/regulatory labels). P7.7 Upgrading can be done e.g. with processor, memory, cards or drives P7.8 Upgrading can be done e.g. with processor, memory, cards or drives P7.9 Spare parts are available after end of production for. 5 years P7.10 Spare parts are available after end of production for. 5 years Material and substance requirements P7.11 Product cover/housing material type: Material type: PC+ABS-FR/40) Material type: Material type: PC+ABS-FR/40) Material type: Material type: PC+ABS-FR/40) Material type: PC+ABS-FR/40) Material type: PC+ABS-FR/40 Material type: PC-ABS-FR/40 Material type: PC-ABS-FR/4					
P7.10 Pastic materials in covers/housing have no surface coating. P7.21 Plastic materials in covers/housing have no surface coating. P7.22 Plastic materials in covers/housing have no surface coating. P7.33 Plastic parts >100g consist of one material or of easily separable materials. P7.44 Plastic parts >25g have material codes according to ISO 11469 referring ISO 1043. P7.55 Plastic parts are free from metal inlays or have inlays that can be removed with commonly available tools. P7.66 Labels are easily separable. (This requirement does not apply to safety/regulatory labels). P7.67 Upgrading can be done e.g., with processor, memory, cards or drives P7.78 Upgrading can be done e.g., with processor, memory, cards or drives P7.79. Spare parts are available after end of production for: 5 years Material and substance requirements P7.10 Service is available after end of production for: 5 years Material and substance requirements P7.11 Product cover/housing material stips: Material type: PC-ABS-FR(40) Material type: Note B2) P7.11 Pinted circuit boards (without components) >25g are halogen free. as defined in IEC61249-2-21. (See Note B2) Note B2) P7.12 Electrical cable insulation materials of signal cables are PVC free. P7.13 Pinten retarded plastic parts >25g in covers / housings are marked according ISO 1043-4: Note B2 P7.14 Pinten retarded plastic parts >25g contain the follow	P6				
P7.1º Parts that have to be treated separately are easily separable P7.2º Plastic materials in covers/housing have no surface coating. P7.3º Plastic parts >100g consist of one material or of easily separable materials. P1.4º Plastic parts >25g have material codes according to ISO 11469 referring ISO 1043. P7.5 Plastic parts >25g have material codes according to ISO 11469 referring ISO 1043. P7.5 Plastic parts >25g have material codes according to ISO 11469 referring ISO 1043. P7.6 Plastic parts >25g have material codes according to ISO 11469 referring ISO 1043. P7.7 Upgrading can be done e.g. with processor, memory, cards or drives P7.7 Upgrading can be done e.g. with processor, memory, cards or drives P7.8 Upgrading can be done e.g. with processor, memory, cards or drives P7.9 Spare parts are available after end of production for: 5 years P7.10 Service is available after end of production for: 5 years Material and substance requirements P7.11 Product cover/housing material type: Material and substance requirements P7.12 Electrical cable insulation materials of power cables are PVC free. P7.13 Electrical cable insulation materials of signal cables are PVC free. P7.14 All cover/housing plastic parts >25g are free from chlorine and bromine. P7.15 All printed circuit boards (without components) >25g are halogen free. as defined in IEC61249-2-21. (See Note E2) P7.16 Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4: Alt. 1 Chemical specifications of flame retardants in printed circuit boards (without components): TBBPA (additive)	P6.1*	Information for recyclers/treatment facilities is available (see legal reference).	\boxtimes		
P7.1º Parts that have to be treated separately are easily separable P7.2º Plastic materials in covers/housing have no surface coating. P7.3º Plastic parts >100g consist of one material or of easily separable materials. P7.4º Plastic parts >20g consist of one material or of easily separable materials. P7.5º Plastic parts >20g have material codes according to ISO 11469 referring ISO 1043. P7.6º Labels are easily separable. (This requirement does not apply to safety/regulatory labels). P7.7º Upgrading can be done e.g. with processor, memory, cards or drives P7.8º Upgrading can be done e.g. with processor, memory, cards or drives P7.8º Upgrading can be done e.g. with processor, memory, cards or drives P7.8º Spare parts are available after end of production for: 5 years P7.99 Spare parts are available after end of production for: 5 years P7.10 Service is available after end of production for: 5 years P7.11º Product cover/housing material type: Material and substance regulrements P7.11º Product cover/housing material type: Material supe: PC+ABS-FR(40) Material supe: PC+ABS-FR(40) Material supe: PC+ABS-FR(40) Material supe: PC+ABS-FR(40) All printed circuit boards (without components) >25g are halogen free. as defined in IEC61249-2-21. (See Note B2) P7.16 Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4: Marking: FR(40) P7.17 Alt. 1 Chemical specifications of flame retardants in printed circuit boards (without components): TBBPA (additive), TBBPA (reactive), Other; chemical name:, CAS #:, Alt. 2 Chemical specifications of flame retardants in printed circuit boards (without components) >25g according , TBBPA (additive), TBBPA (reactive), Other; chemical name:, CAS #:, Comment. No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name, CAS #:, Supplier:	P7				
P7.2° Plastic materials in covers/housing have no surface coating. P7.3° Plastic parts >100g consist of one material or of easily separable materials. P1.4° Plastic parts >25g have material codes according to ISO 11469 referring ISO 1043. P7.5° Plastic parts >25g have material codes according to ISO 11469 referring ISO 1043. P7.6° Labels are easily separable. (This requirement does not apply to safety/regulatory labels). Product lifetime P7.7° Upgrading can be done e.g. with processor, memory, cards or drives P7.8° Upgrading can be done using commonly available tools P7.9. Spare parts are available after end of production for: 5 years P7.10 Service is available after end of production for: 5 years P7.11 Service is available after end of production for: 5 years P7.12 Electrical cable insulation materials of power cables are PVC free. P7.13 Electrical cable insulation materials of power cables are PVC free. P7.14 All cover/housing plastic parts >25g are free from chlorine and bromine. P7.15 All printed circuit boards (without components) >25g are halogen free. as defined in IEC61249-2-21. (See Note B2) P7.16 Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4: Alt. 1 Chemical specifications of flame retardants in printed circuit boards (without components): TBBPA (additive) , TBBPA (reactive) , Other; chemical name: , CAS #: Alt. 2 Chemical specifications of flame retardants in printed circuit boards (without components): TBBPA (additive) , TBBPA (reactive) , Other; chemical name: , CAS #: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name. , CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: 4. Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:					
P7.3* Plastic parts >100g consist of one material or of easily separable materials. P7.4* Plastic parts >25g have material codes according to ISO 11469 referring ISO 1043.		Parts that have to be treated separately are easily separable	\boxtimes		
P7.4* Plastic parts >25g have material codes according to ISO 11469 referring ISO 1043.	P7.2*	Plastic materials in covers/housing have no surface coating.	\boxtimes		
P7.5 Plastic parts are free from metal inlays or have inlays that can be removed with commonly available tools. P7.6 Labels are easily separable. (This requirement does not apply to safety/regulatory labels). Product lifetime P7.7 Upgrading can be done e.g. with processor, memory, cards or drives Upgrading can be done using commonly available tools P7.9 Spare parts are available after end of production for: 5 years Material and substance requirements P7.110 Service is available after end of production for: 5 years Material and substance requirements P7.111 Product cover/housing material type: Material and substance requirements P7.112 Electrical cable insulation materials of power cables are PVC free. P7.12 Electrical cable insulation materials of signal cables are PVC free. P7.13 Electrical cable insulation materials of signal cables are PVC free. P7.14 All cover/housing plastic parts >25g are free from chlorine and bromine. All printed circuit boards (without components) >25g are halogen free. as defined in IEC61249-2-21. (See Note B2) P7.16 Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4: Narking: FR(40) P7.17 Alt. 1 Chemical specifications of flame retardants in printed circuit boards >25g (without components): TBBPA (additive) , TBBPA (reactive) , Other; chemical name: , CAS #: Alt. 2 Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: Brominated Epoxy Resin See P14 P7.18 Alt. 1 Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.19%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name: , CAS #: , Supplier: 1. Chemical aname: , CAS #: , Supplier: 2. Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:	P7.3*	Plastic parts >100g consist of one material or of easily separable materials.			
P7.5 Plastic parts are free from metal inlays or have inlays that can be removed with commonly available tools. P7.6 Labels are easily separable. (This requirement does not apply to safety/regulatory labels). Product lifetime P7.7 Upgrading can be done e.g. with processor, memory, cards or drives P7.8 Upgrading can be done using commonly available tools P7.9 Spare parts are available after end of production for: 5 years P7.10 Service is available after end of production for: 5 years Material and substance requirements P7.11 Product cover/housing material type: Material and substance requirements P7.12 Electrical cable insulation materials of power cables are PVC free. P7.13 Electrical cable insulation materials of signal cables are PVC free. P7.14 All cover/housing palsatic parts >25g are free from chlorine and bromine. P7.15 All printed circuit boards (without components) >25g are halogen free. as defined in IEC61249-2-21. (See Note B2) P7.16 Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4: Note B2) P7.17 Alt. 1 Chemical specifications of flame retardants in printed circuit boards >25g (without components): TBBPA (additive) , TBBPA (reactive) , Other; chemical name: , CAS #: Alt. 2 Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: BPP.18 Alt. 1 Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.19%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name: , CAS #: , Supplier: 1. Chemical aname: , CAS #: , Supplier: 2. Chemical aname: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: 4. Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:	P7.4*	Plastic parts >25g have material codes according to ISO 11469 referring ISO 1043.	\overline{X}		
P7.6* Labels are easily separable. (This requirement does not apply to safety/regulatory labels). Product lifetime Upgrading can be done e.g. with processor, memory, cards or drives P7.7* Upgrading can be done using commonly available tools P7.9. Spare parts are available after end of production for: 5 years P7.10 Service is available after end of production for: 5 years Material and substance requirements P7.11* Product cover/housing material type: Material uppe: PC+ABS-FR(40) P7.12 Electrical cable insulation materials of power cables are PVC free. P7.13 Electrical cable insulation materials of signal cables are PVC free P7.14 All cover/housing plastic parts >25g are free from chlorine and bromine. P7.15 All printed circuit boards (without components) >25g are halogen free. as defined in IEC61249-2-21. (See Note B2) P7.17 Alt. 1 Chemical specifications of flame retardants in printed circuit boards >25g (without components): TBBPA (additive) TBBPA (reactive) Other; chemical name: , CAS #: Alt. 2 Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: Brominated Epoxy Resin See P14 P7.18 Alt. 1 Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: Chemical specifications of flame retardants including MSDS for each flame retardant. The list must contain complete chemical name: , CAS #: , Supplier: 1. Chemical name: , CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:	P7.5	Plastic parts are free from metal inlays or have inlays that can be removed with commonly available tools.		$\overline{\sqcap}$	$\overline{\Box}$
Product lifetime P7.7* Upgrading can be done e.g. with processor, memory, cards or drives □ Upgrading can be done using commonly available tools □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □	P7.6*	Labels are easily separable. (This requirement does not apply to safety/regulatory labels).		$\overline{\sqcap}$	$\overline{\Box}$
P7.8* Upgrading can be done using commonly available tools P7.9. Spare parts are available after end of production for: 5 years P7.10 Service is available after end of production for: 5 years P7.11* Product cover/housing material type: Material type: PC-ABS-FR(40) Material type: P7.12 Electrical cable insulation materials of signal cables are PVC free P7.14 All cover/housing plastic parts >25g are free from chlorine and bromine. P7.15 All printed circuit boards (without components) >25g are halogen free. as defined in IEC61249-2-21. (See Note B2) P7.16 Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4: Marking: FR(40) P7.17 Alt. 1 Chemical specifications of flame retardants in printed circuit boards >25g (without components): TBBPA (additive) TBBPA (reactive) , Other; chemical name: , CAS #: Alt. 2 Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: Brominated Epoxy Resin See P14 P7.18 Alt. 1 Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name: , CAS #: , Supplier: 1. Chemical name: , CAS #: , Supplier: 2. Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4: Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:		Product lifetime			
P7.8* Upgrading can be done using commonly available tools P7.9. Spare parts are available after end of production for: 5 years P7.10 Service is available after end of production for: 5 years P7.11* Product cover/housing material type: Material type: PC-ABS-FR(40) Material type: P7.12 Electrical cable insulation materials of signal cables are PVC free P7.14 All cover/housing plastic parts >25g are free from chlorine and bromine. P7.15 All printed circuit boards (without components) >25g are halogen free. as defined in IEC61249-2-21. (See Note B2) P7.16 Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4: Marking: FR(40) P7.17 Alt. 1 Chemical specifications of flame retardants in printed circuit boards >25g (without components): TBBPA (additive) TBBPA (reactive) , Other, chemical name: , CAS #: Alt. 2 Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: Brominated Epoxy Resin See P14 P7.18 Alt. 1 Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name: , CAS #: , Supplier: 1. Chemical name: , CAS #: , Supplier: 2. Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:	P7.7*	Upgrading can be done e.g. with processor, memory, cards or drives	\square	П	
P7.9. Spare parts are available after end of production for: 5 years	P7.8*			Ħ	Ħ
P7.10 Service is available after end of production for: 5 years Material and substance requirements					Ħ
Material and substance requirements P7.11* Product cover/housing material type: Material type: PC+ABS-FR(40)					Ħ
P7.11* Product cover/housing material type: Material type: PC+ABS-FR(40) P7.12 Electrical cable insulation materials of power cables are PVC free. P7.13 Electrical cable insulation materials of signal cables are PVC free P7.14 All cover/housing plastic parts >25g are free from chlorine and bromine. P7.15 All printed circuit boards (without components) >25g are halogen free. as defined in IEC61249-2-21. (See Note B2) P7.16 Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4: Marking: FR(40) P7.17 Alt. 1 Chemical specifications of flame retardants in printed circuit boards >25g (without components): TBBPA (additive) , TBBPA (reactive) , Other; chemical name: , CAS #: Alt. 2 Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: Brominated Epoxy Resin See P14 P7.18 Alt. 1 Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name: , CAS #: , Supplier: 1. Chemical name: , CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: 4.1. 2 Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:					
Material type: PC+ABS-FR(40) P7.12 Electrical cable insulation materials of power cables are PVC free. P7.13 Electrical cable insulation materials of signal cables are PVC free. P7.14 All cover/housing plastic parts >25g are free from chlorine and bromine. P7.15 All printed circuit boards (without components) >25g are halogen free. as defined in IEC61249-2-21. (See Note B2) P7.16 Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4: Marking: FR(40) P7.17 Alt. 1 Chemical specifications of flame retardants in printed circuit boards >25g (without components): TBBPA (additive) TBBPA (reactive) Other; chemical name: Note P1.18 Alt. 1 Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name: 1. Chemical name: 2. Chemical name: 3. Chemical name: 4. CAS #: 5. Supplier: 3. Chemical name: 4. CAS #: 5. Supplier: 4. Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4: Chemical specifications of flame retardants including MSDS for each flame retardant. The list must contain complete chemical name: CAS #: 5. Supplier: Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:	P7 11*	·			
P7.12 Electrical cable insulation materials of power cables are PVC free. P7.13 Electrical cable insulation materials of signal cables are PVC free P7.14 All cover/housing plastic parts >25g are free from chlorine and bromine. P7.15 All printed circuit boards (without components) >25g are halogen free. as defined in IEC61249-2-21. (See Note B2) P7.16 Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4: Marking: FR(40) P7.17 Alt. 1 Chemical specifications of flame retardants in printed circuit boards >25g (without components): TBBPA (additive) , TBBPA (reactive) , Other; chemical name: , CAS #: Alt. 2 Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: Brominated Epoxy Resin See P14 P7.18 Alt. 1 Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name. , CAS #: , Supplier: 1. Chemical name: , CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: 4. L. 2 Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:					
P7.13 Electrical cable insulation materials of signal cables are PVC free P7.14 All cover/housing plastic parts >25g are free from chlorine and bromine. P7.15 All printed circuit boards (without components) >25g are halogen free. as defined in IEC61249-2-21. (See Note B2) P7.16 Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4: Marking: FR(40) P7.17 Alt. 1 Chemical specifications of flame retardants in printed circuit boards >25g (without components): TBBPA (additive) TBBPA (reactive) Other; chemical name: Alt. 2 Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: Brominated Epoxy Resin See P14 P7.18 Alt. 1 Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name; , CAS #: , Supplier: 1. Chemical name: , CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: 3. Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:	P7.12			\boxtimes	
P7.14 All cover/housing plastic parts >25g are free from chlorine and bromine. P7.15 All printed circuit boards (without components) >25g are halogen free. as defined in IEC61249-2-21. (See Note B2) P7.16 Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4: Marking: FR(40) P7.17 Alt. 1 Chemical specifications of flame retardants in printed circuit boards >25g (without components): TBBPA (additive) , TBBPA (reactive) , Other; chemical name: , CAS #: Alt. 2 Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: Brominated Epoxy Resin See P14 P7.18 Alt. 1 Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name; , CAS #: , Supplier: 1. Chemical name: , CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: 4. L2 Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:	P7.13	Electrical cable insulation materials of signal cables are PVC free		_	Ħ
P7.15 All printed circuit boards (without components) >25g are halogen free. as defined in IEC61249-2-21. (See Note B2) P7.16 Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4:	P7.14	<u> </u>			H
P7.16 Flame retarded plastic parts >25g in covers / housings are marked according ISO 1043-4: Marking: FR(40)				$\overline{\forall}$	H
P7.17 Alt. 1 Chemical specifications of flame retardants in printed circuit boards >25g (without components): TBBPA (additive) ☐, TBBPA (reactive) ☒, Other; chemical name: , CAS #: Alt. 2 Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: **Brominated Epoxy Resin See P14* P7.18 Alt. 1 Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name, CAS number and supplier. 1. Chemical name: , CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: Alt. 2 Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:			ш		ш
P7.17 Alt. 1 Chemical specifications of flame retardants in printed circuit boards >25g (without components): TBBPA (additive) ☐, TBBPA (reactive) ☑, Other; chemical name: , CAS #: Alt. 2 Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: Brominated Epoxy Resin See P14 P7.18 Alt. 1 Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name; , CAS #: , Supplier: 1. Chemical name: , CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: Alt. 2 Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:	P7.16		\boxtimes		
Chemical specifications of flame retardants in printed circuit boards >25g (without components): TBBPA (additive) , TBBPA (reactive) , Other; chemical name: , CAS #: Alt. 2 Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: **Brominated Epoxy Resin See P14* P7.18 Alt. 1 Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name, CAS number and supplier. 1. Chemical name: , CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: Alt. 2 Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:					
TBBPA (additive) , TBBPA (reactive) , Other; chemical name: , CAS #: Alt. 2 Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: Brominated Epoxy Resin See P14 P7.18 Alt. 1 Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name, CAS number and supplier. 1. Chemical name: , CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: Alt. 2 Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:	P7.17				
Alt. 2 Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: Brominated Epoxy Resin See P14 P7.18 Alt. 1 Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name, CAS number and supplier. 1. Chemical name: , CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: Alt. 2 Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:			ш	ш	Ш
Chemical specifications of flame retardants in printed circuit boards (without components) >25g according ISO 1043-4: Brominated Epoxy Resin See P14 P7.18 Alt. 1 Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name, CAS number and supplier. 1. Chemical name: , CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: Alt. 2 Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:		, and the second of the second			
P7.18 Alt. 1 Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name, CAS number and supplier. 1. Chemical name: , CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: Alt. 2 Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:					
P7.18 Alt. 1 Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name, CAS number and supplier. 1. Chemical name: , CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: Alt. 2 Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:					
Flame retarded plastic parts >25g contain the following flame retardant substances/preparations in concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name, CAS number and supplier. 1. Chemical name: , CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: Alt. 2 Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:	D7.40				
concentrations above 0.1%: Comment: No legal limits exist, this is a market requirement. Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name, CAS number and supplier. 1. Chemical name: , CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: Alt. 2 Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:	P7.18				
Provide a list of all used flame retardants including MSDS for each flame retardant. The list must contain complete chemical name, CAS number and supplier. 1. Chemical name: , CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: Alt. 2 Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:			ш	ш	Ш
complete chemical name, CAS number and supplier. 1. Chemical name: , CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: Alt. 2 Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:		Comment: No legal limits exist, this is a market requirement.			
1. Chemical name: , CAS #: , Supplier: 2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: Alt. 2 Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:					
2. Chemical name: , CAS #: , Supplier: 3. Chemical name: , CAS #: , Supplier: Alt. 2 Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:					
3. Chemical name: , CAS #: , Supplier: Alt. 2 Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:		, , , , , , , , , , , , , , , , , , , ,			
Alt. 2 Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:					
Chemical specifications of flame retardants in plastic parts >25g according ISO 1043-4:			\boxtimes		
FR(40)					
P7.19 Plastic parts >25g are free from flame retardant substances/ preparations above 0.1% classified as R45,	P7.19	Plastic parts >25g are free from flame retardant substances/ preparations above 0.1% classified as R45,			
R40, R46, R48, R50, R51, R53, R60, R61 and any combination of these (See Note B3)					
P7.20 Of total plastic parts' weight >25g, recycled material content is 0%.					
P7.21 Of total plastic parts' weight >25g, biobased material content is 0% .					_
, , , , , , , , , , , , , , , , , , , ,		Light sources are free from mercury			
P8 Batteries P9 1* Pottory chemical composition: Lithium Inn/Lithium Manageness Dioxide					
P8.1* Battery chemical composition: Lithium Ion/Lithium Manganese Dioxide P8.2 Batteries meet the requirements of the following voluntary program/s: US RRPC		· · · · · · · · · · · · · · · · · · ·			

Note B2: IEC61249-2--21 has maximum limits for chlorine and bromine but does not address fluorine, iodine and astatine which are included in the group of halogens.

Note B3: 'Starting from January 2009, Risk phrases can be replaced by Hazard phrases according to the Globally Harmonized System (GHS), mandatory by December 2010.

Model number *	Lenovo G560e		
Issue date *	2011-1-17	Logo	lenovo

Product environmen	duct environmental attributes - Market requirements (continued) Requirement me						met
Item							n.a.
P9 Energy consumption							
The product	For the product the following power levels or energy consumptions are reported: See P14 The product is shipped w/ WOL Enabled.						
Energy mode *	Power 16 100 V A		Power level at 115 V AC	Power level at 230 V AC	Reference / Standa and test method *	rd for energy modes	
Peak (On-max)	<i>65</i> W		<i>65</i> W	<i>65</i> W	Full load		
Category A	Category A					1	
Idle State - WOL Enable	ed 6. 280W		6. 310W	<i>6. 580</i> W	Use for Energy Star	V5 registration(P _{idle})	
Sleep (S3) - WOL Enab	led 0.918 W		0.922 W	<i>0.</i> 95 <i>0</i> W	Use for Energy Star	V5 registration(P _{sleep})	
Sleep (S3) - WOL Disak	oled 0.834 W		0.837 W	<i>0.8</i> 69 W	Reference		
Off (S5) - WOL Enabled	0.572 W		0.574 W	0.610 W	Use for Energy Star	V5 registration(P _{off})	
Off (S5) - WOL Disable	<i>0.571</i> W		0.573 W	0.607 W	Use for EuP		
EPS No-load (External power supply / charger plugged in the w outlet but disconnected f the product.)			0.228 W	0.280 W			
TEC Typical Energy Consump		h/week	kWh/week	kWh/week			
ETEC * Annual Energy Consump	20.314 kW	/h/year	20.407 kWh/year	21.331 kWh/year	$E_{TEC} = (8760/1000)$ 0.1 + $P_{idle} \times 0.3$)	$x (P_{off} \times 0.6 + P_{sleep} \times 0.6 + P_{sleep}$	
	Poff: Off Mode(S5) - WOL Enabled; Psleep: Sleep Mode(S3) - WOL Enabled; Pidle: Idle State - WOL Enabled						
Display resolution : 12	30*800 Megapixel	S					
Print Speed :	Print Speed : Images per minute						
Default time to enter ene	rgy save mode: 2	5 minute	es				\Box
P9.2* Information a	bout the energy s	ave fund	ction is provided with	the product.			
ENERGY ST Others speci	AR® version: Ve	rsion 5.0	nents of the following O dated July 1, 2009 nal Power Supplies	Product category:	: A		
P10 Emissions Noise emiss	sion – Declared a	ccording	to ISO 9296				
P10.1 Mode	Mode descri		0.000 0200	Declared A-weighted sound power	Declared A sound pressure I	evel $L_{p{\sf Am}}$ (dB)	
				level $L_{W\!Ad}$ (B)	Operator position Desktop Or Desk side	Bystander positions (only if product is not operator attended)	
Idle	* HDD: Idle			* 2.9	23		
Operation	* HDD: Ope	rating		* 3.0	24	1.0	
Other mode			_				
Measured ad	cording to: 🔀 IS:	07779 <mark>L</mark> ther	ECMA-74 (only if not cover	ed by ECMA-74 wit	h L _{pAm} measurement d	istance m)	
P10.2 The product							

Model nui	mber *	Lenovo G560e					
Issue date) *	2011-1-17	Logo	le	no	VO	
Product	environn	nental attributes - Market requirements (continued)		Po	quire	mont	mot
Item	CIIVIIOIII	mentar attributes - market requirements (continued)		1/6	Yes	No	n.a.
	Chemica	al emissions from printing products					
P10.3*		formed according to ECMA-328 (ISO/IEC 28360) standard, other specify:				П	\boxtimes
P10.4		emission rate (print phase) is (mg/h):					
		Dust Ozone Styrene Benzene TVOC					
P10.5		al emission requirements of the following voluntary program/s are met for : Oust Ozone Styrene Benzene	TVOC 🗌				
		nagnetic emissions	1000				
P10.6	Compute	er display meets the requirement for low frequency electromagnetic fields of the foll /s: MPR-II	owing volur	ntary			
P11		nable materials for printing products					
P11.1*	A Safety	Data Sheet (SDS) is available for the ink/toner preparation, even if not legally requ	ired (see P	4.3).			\boxtimes
P11.2*	EN1228		e requirem	ents of			
P11.3*	2-sided ((duplex) printing/copying is an integrated product function.					\boxtimes
P12		mics for computing products					
P12.1*		play meets the ergonomic requirements of ISO 9241-307 for visual display technolo	gies.		\boxtimes		
P12.2*	The phys	sical input device meets the requirements of ISO 9995 and ISO 9241-410.			\boxtimes		
P13		ng and documentation					
P13.1*	Product	packaging material type(s): Corrugated Carton weight (kg): 0.378 packaging material type(s): Polyethylene Cushions weight (kg): 0.058 packaging material type(s): Others weight (kg): 0.230					
P13.2*	Product	plastic packaging is free from PVC.			\boxtimes		
P13.3*		media for user and product documentation (tick box): ic ☑, Paper ☑, Other □					
P13.4*		er user and product documentation, please specify contained percentage of post-co % (Japan only 70%)	nsumer red	cycled			
P14		nal information (See Note B4)					
	informati knowled provided informati		nt is provide ate such info account Rep	ed based ormation.	on support on the information of the support of the	plier's format	
P7.17		t does not contain free TBBPA in printed circuit boards(without components):	>25g.				
P9		ergy Star Qualified Notebooks & Tablet Computers for the latest information: pwnloads.energystar.gov/bi/qplist/laptops_prod_list.xls					

Note B4: Additional lines may be inserted to declare further items, by positioning the cursor at the far right of the row and hitting the <Enter> key.

Legal references Europe Annex B

Reference	Declaration item
2002/95/EC (ROHS Directive)	P1.1, P4.1
REACH, Annex XVII	P1.6, P1.8, P4.2
REACH, Annex XVII	P1.4
REACH, Annex XVII	P1.2
REACH, Annex XVII	P1.7
REACH, Annex XVII	P1.9
Regulation (EC) No. 2037/2000, 2038/2000, 2039/2000	P1.3
Norwegian regulation relating to restrictions on the use of certain dangerous chemicals 20.12.2002	P1.5
2006/66/EC (Battery and accumulators Directive)	P2.1, P2.2, P2,3, P3.4, P8.1
2006/95/EC (Low Voltage Directive)	P3.1, 3.4
2004/108/EEC (New EMC Directive)	P3.2, 3.4
1999/5/EC (R&TTE Directive)	P3.3, 3.4
"REACH" Regulation (1907/2006), annex VII	P1.10
(EC) No.1272/2008 regulation on classification, labeling and packaging (CLP)	P4.3
REACH article 31, annex II	P4.3
2004/12/EC (Directive on packaging and packaging waste)	P5.1
(97/129/EC) (Commission Decision on Identification System for Packaging Materials	P5.2
2037/2000/EC Regulation on Substances that Deplete the Ozone Layer	P5.3
2002/96/EC (WEEE directive)	P3.4, P6.1
(EC) No.1272/2008 regulation on classification, labeling and packaging (CLP)	P7.19